

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ching-Wei Chu	01/18/2008
Cheng-Wen Li	01/18/2008
Chien-Chang Yang	01/18/2008
Chang-Lung Pan	01/18/2008
RECEIVING PARTY DATA	
Name:	Au Optronics Corporation
Street Address:	No. 1, Li-Hsin Rd. II, Science-Based Industrial Park,
City:	Hsinchu
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12025787
CORRESPONDENCE DATA	
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Correspondent Name:	JIANQ CHYUN INTELLECTUAL PROPERTY
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ATTORNEY DOCKET NUMBER:	25439-US-PA
NAME OF SUBMITTER:	Belinda Lee
Total Attachments: 2 source=25439assignment#page1.tif source=25439assignment#page2.tif	

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PATENT

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REEL: 020557 FRAME: 0579

ASSIGNMENT

WHEREAS,

- | | |
|----------------------|--------------------|
| 1. Chu, Ching-Wei | 2. Li, Cheng-Wen |
| 3. Yang, Chien-Chang | 4. Pan, Chang-Lung |

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **ION EXCHANGE RESIN TOWER AND DETECTION METHOD OF LIFETIME OF RESIN THEREIN**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, Au Optronics Corporation
of No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Ching-Wei Chu
Sole or First Joint Inventor: Chu, Ching-Wei

Date: 01/18/2008

Signature: Li Cheng-Wen
Second Joint Inventor (if any): Li, Cheng-Wen

Date: 01/18/2008

Signature: Yang Chien-Chang
Third Joint Inventor (if any): Yang, Chien-Chang

Date: 01/18/2008

Signature: Pan Chang-Lung
Fourth Joint Inventor (if any): Pan, Chang-Lung

Date: 01/18/2008